

## **AUV3-Sxx2-0xx0K**

### **3W 3535 Surface-Mount UV LED**



### **Description**

The Broadcom® 3W 3535 surface-mount UV LEDs are energy-efficient LEDs that can be driven with high currents and can dissipate heat efficiently, resulting in higher reliability. Their low-profile package design addresses a wide variety of applications where superior robustness and high efficiency are required. They are packaged with ceramic-based materials, and the quartz lens on top of the package provides the product longevity needed for the respective end applications.

To facilitate easy pick-and-place assembly, the LEDs are packed in tape and reel. Each reel is shipped in a single flux and single color bin to ensure close uniformity.

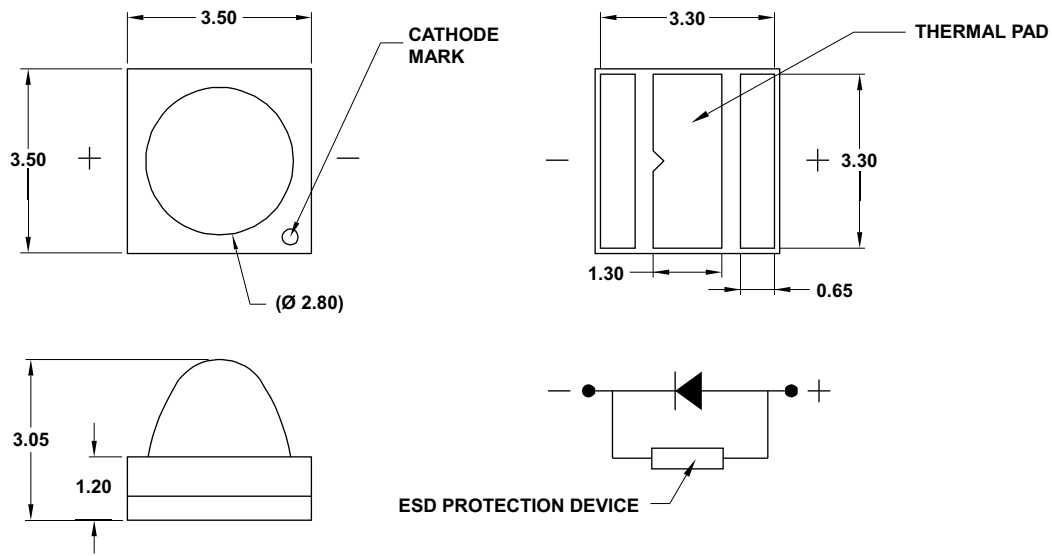
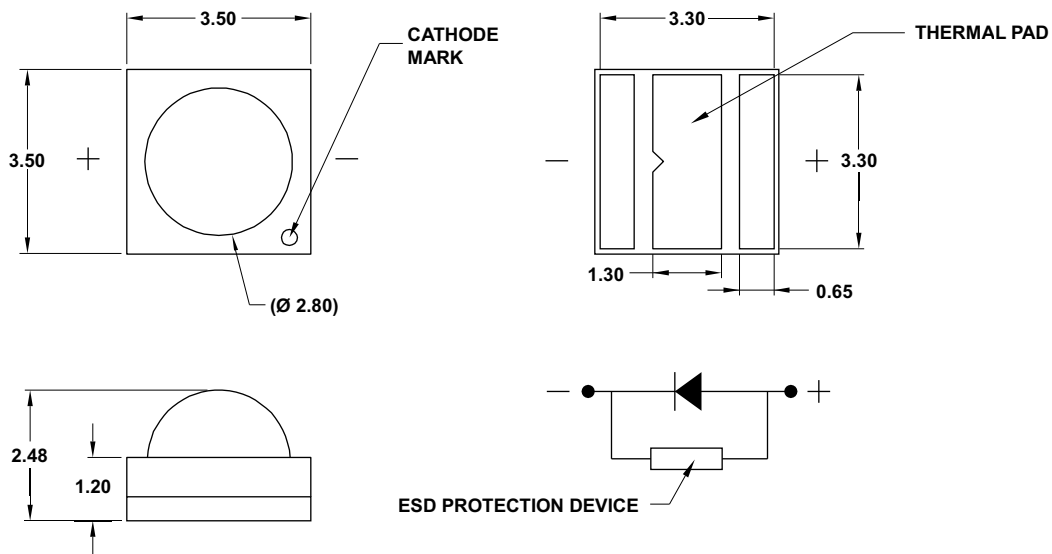
### **Features**

- High-reliability package with quartz lens.
- High-radiant flux output using InGaN dice technology.
- Available in 360-nm to 400-nm wavelength range.
- Available in 35° and 60° viewing angles.
- Compatible with the reflow soldering process.
- JEDEC MSL 1

### **Applications**

- Industrial curing
- Photocatalyst purification
- Medical applications
- Horticulture

**CAUTION!** This LED is ESD sensitive. Observe appropriate precautions during handling and processing. Refer to the *Premium InGaN LEDs: Safety Handling Fundamentals ESD Application Note, AN-1142*, for additional details.

**Figure 1: Package Drawing for AUV3-Sx32-0xx0K****Figure 2: Package Drawing for AUV3-Sx62-0xx0K****NOTE:**

1. All dimensions are in millimeters (mm).
2. Tolerance is  $\pm 0.20$  mm unless otherwise specified.
3. The thermal pad is electrically isolated.
4. Lens = Quartz.
5. Terminal finish = Gold plating
6. Dimensions in parentheses are for reference only.

## Device Selection Guide ( $T_J = 25^\circ\text{C}$ , $I_F = 700\text{ mA}$ )

| Part Number     | Viewing Angle,<br>$2\theta_{1/2}$ ( $^\circ$ ) <sup>a</sup> | Peak Wavelength, $\lambda_p$ (nm) |      |      | Radiant Flux, $\Phi_e$ (mW) <sup>b, c</sup> |      |      | Dice Technology |
|-----------------|-------------------------------------------------------------|-----------------------------------|------|------|---------------------------------------------|------|------|-----------------|
|                 | Typ.                                                        | Min.                              | Typ. | Max. | Min.                                        | Typ. | Max. |                 |
| AUV3-SQ32-0RT0K | 35                                                          | 360                               | 365  | 370  | 910                                         | 1020 | 1210 | InGaN           |
| AUV3-SS32-0RU0K | 35                                                          | 380                               | 385  | 390  | 910                                         | 1020 | 1330 | InGaN           |
| AUV3-ST32-0SV0K | 35                                                          | 390                               | 395  | 400  | 1000                                        | 1200 | 1460 | InGaN           |
| AUV3-SQ62-0RT0K | 60                                                          | 360                               | 365  | 370  | 910                                         | 1020 | 1210 | InGaN           |
| AUV3-SS62-0RU0K | 60                                                          | 380                               | 385  | 390  | 910                                         | 1020 | 1330 | InGaN           |
| AUV3-ST62-0SV0K | 60                                                          | 390                               | 395  | 400  | 1000                                        | 1200 | 1460 | InGaN           |

a.  $\theta_{1/2}$  is the off-axis angle where the radiant flux is half of the peak intensity.

b. Radiant flux,  $\Phi_e$  is the total output measured with an integrating sphere at a single current pulse condition.

c. Tolerance is  $\pm 10\%$ .

## Absolute Maximum Ratings

| Parameters                      | 365 nm                                  | 385 nm | 395 nm | Units            |
|---------------------------------|-----------------------------------------|--------|--------|------------------|
| DC Forward Current <sup>a</sup> | 700                                     | 1000   | 1000   | mA               |
| Power Dissipation               | 2800                                    | 4000   | 4000   | mW               |
| Reverse Voltage                 | Not designed for reverse bias operation |        |        |                  |
| LED Junction Temperature        | 90                                      |        |        | $^\circ\text{C}$ |
| Operating Temperature Range     | $-40$ to $+100$                         |        |        | $^\circ\text{C}$ |
| Storage Temperature Range       | $-40$ to $+100$                         |        |        | $^\circ\text{C}$ |

a. Derate linearly as shown in [Figure 13](#), [Figure 14](#), [Figure 15](#), and [Figure 16](#).

## Optical and Electrical Characteristics ( $T_J = 25^\circ\text{C}$ , $I_F = 700\text{ mA}$ )

| Parameters                                        | Min. | Typ. | Max. | Units              |
|---------------------------------------------------|------|------|------|--------------------|
| Spectral Half-Width, $\Delta\lambda_{1/2}$        |      |      |      | nm                 |
| 365 nm                                            | —    | 11   | —    |                    |
| 385 nm                                            | —    | 11   | —    |                    |
| 395 nm                                            | —    | 12   | —    |                    |
| Forward Voltage, $V_F$ <sup>a</sup>               |      |      |      | V                  |
| 365 nm                                            | 3.40 | 3.70 | 4.00 |                    |
| 385 nm                                            | 3.20 | 3.45 | 4.00 |                    |
| 395 nm                                            | 3.20 | 3.45 | 4.00 |                    |
| Thermal Resistance, $R_{\theta J-S}$ <sup>b</sup> | —    | 6    | —    | $^\circ\text{C/W}$ |

a. Forward voltage,  $V_F$ , tolerance is  $\pm 0.1\text{V}$ .

b. Thermal resistance from the LED junction to the solder point.

## Part Numbering System

A U V 3 - S x<sub>1</sub> x<sub>2</sub> 2 - 0 x<sub>3</sub> x<sub>4</sub> x<sub>5</sub> x<sub>6</sub>

| Code           | Description              | Option                                                           |                       |
|----------------|--------------------------|------------------------------------------------------------------|-----------------------|
| x <sub>1</sub> | Nominal Peak Wavelength  | Q                                                                | 365 nm                |
|                |                          | S                                                                | 385 nm                |
|                |                          | T                                                                | 395 nm                |
| x <sub>2</sub> | Viewing Angle            | 3                                                                | 35°                   |
|                |                          | 6                                                                | 60°                   |
| x <sub>3</sub> | Minimum Radiant Flux Bin | Refer to the <a href="#">Radiant Flux Bin Limits (CAT)</a> table |                       |
| x <sub>4</sub> | Maximum Radiant Flux Bin |                                                                  |                       |
| x <sub>5</sub> | Color Bin Option         | 0                                                                | Full Distribution     |
| x <sub>6</sub> | Test Option              | K                                                                | Test Current = 700 mA |

## Part Number Example

AUV3-SS32-0RU0K

- x<sub>1</sub>: S – Nominal peak wavelength = 385 nm
- x<sub>2</sub>: 3 – Viewing angle = 35°
- x<sub>3</sub>: R – Minimum radiant flux bin R
- x<sub>4</sub>: U – Maximum radiant flux bin U
- x<sub>5</sub>: 0 – Full distribution color bin
- x<sub>6</sub>: K – Test current = 700 mA

## Bin Information

### Radiant Flux Bin Limits (CAT)

| Bin ID | Radiant Flux, $\Phi_e$ (mW) |      |
|--------|-----------------------------|------|
|        | Min.                        | Max. |
| Q      | 830                         | 910  |
| R      | 910                         | 1000 |
| S      | 1000                        | 1100 |
| T      | 1100                        | 1210 |
| U      | 1210                        | 1330 |
| V      | 1330                        | 1460 |

Tolerance =  $\pm 10\%$ .

### Forward Voltage Bin Limits ( $V_F$ )

| Bin ID | Forward Voltage, $V_F$ (V) |      |
|--------|----------------------------|------|
|        | Min.                       | Max. |
| D      | 3.2                        | 3.4  |
| E      | 3.4                        | 3.6  |
| F      | 3.6                        | 3.8  |
| G      | 3.8                        | 4.0  |

Tolerance =  $\pm 0.1V$ .

### Color Bin Limits (BIN)

| Bin ID | Peak Wavelength, $\lambda_p$ (nm) |      |
|--------|-----------------------------------|------|
|        | Min.                              | Max. |
| Q1     | 360                               | 365  |
| Q2     | 365                               | 370  |
| S1     | 380                               | 385  |
| S2     | 385                               | 390  |
| T1     | 390                               | 395  |
| T2     | 395                               | 400  |

Tolerance =  $\pm 1.0$  nm.

Example of bin information on reel and packaging label:

CAT: S – Radiant flux bin S  
 BIN: S1 – Color bin S1  
 VF: E – Forward voltage bin E

Figure 3: Spectral Power Distribution

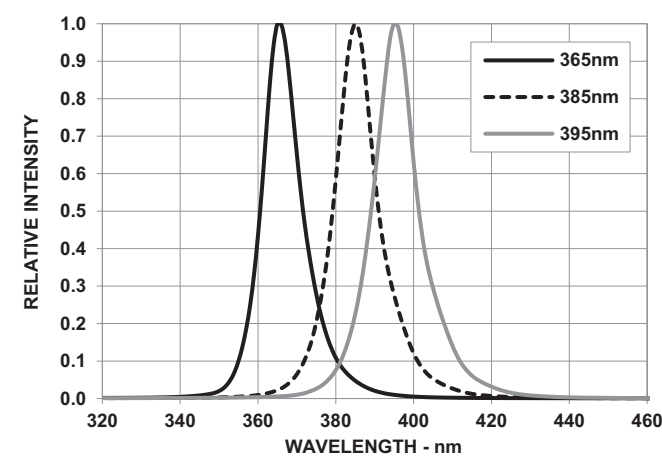


Figure 4: Forward Current vs. Forward Voltage

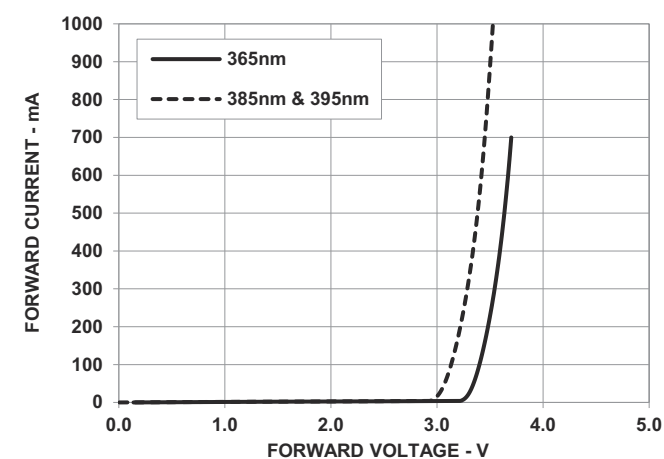


Figure 5: Relative Radiant Flux vs. Mono Pulse Current – 365 nm

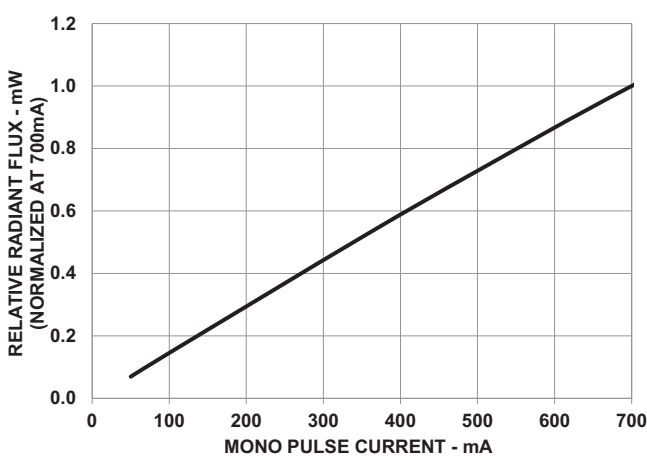


Figure 6: Relative Radiant Flux vs. Mono Pulse Current – 385 nm and 395nm

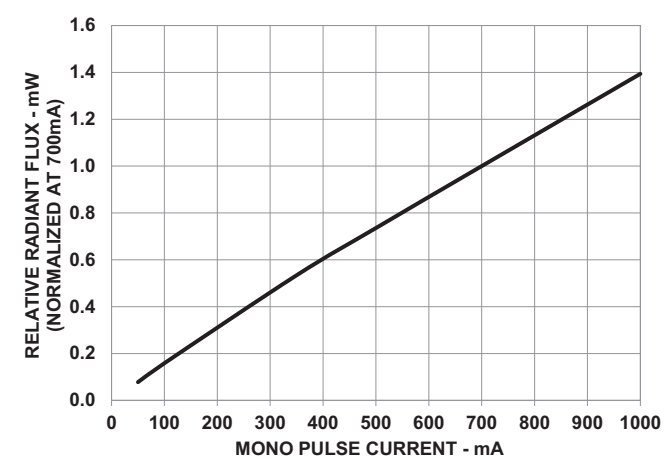


Figure 7: Relative Radiant Flux vs. Mono Pulse Current – 365 nm

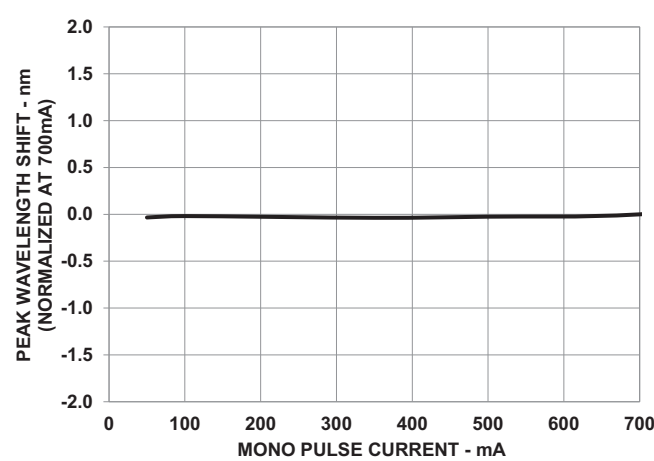


Figure 8: Peak Wavelength Shift vs. Mono Pulse Current – 385 nm and 395 nm

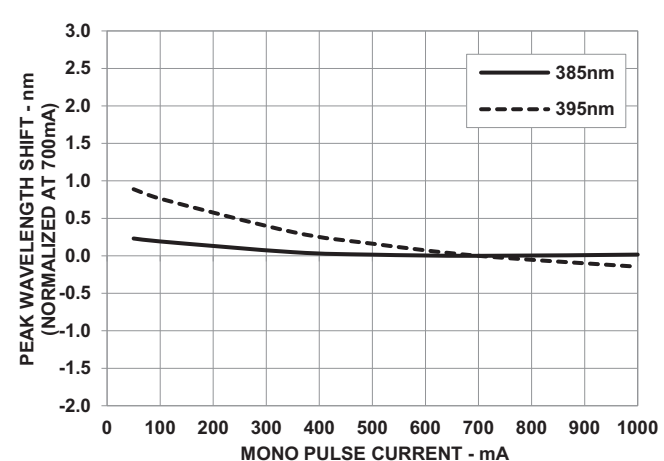


Figure 9: Radiation Pattern – 60°

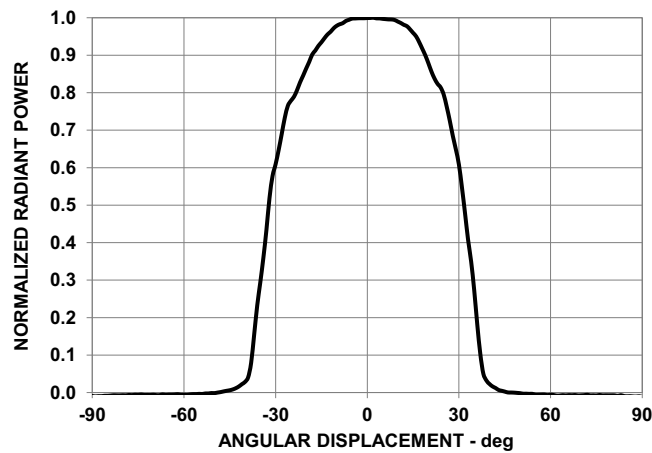


Figure 10: Radiation Pattern – 35°

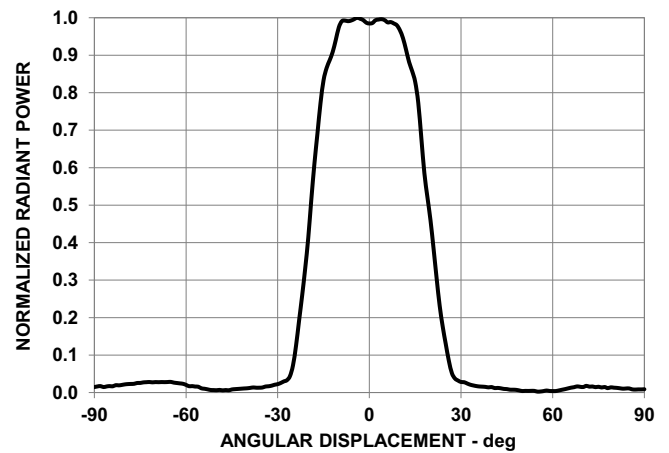


Figure 11: Forward Voltage Shift vs. Junction Temperature

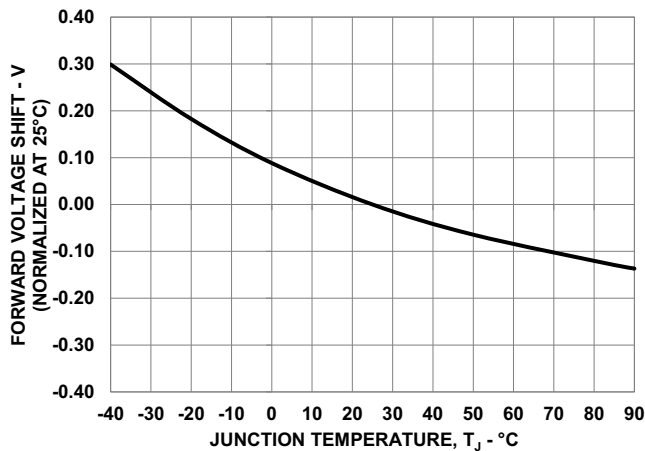


Figure 12: Peak Wavelength Shift vs. Junction Temperature

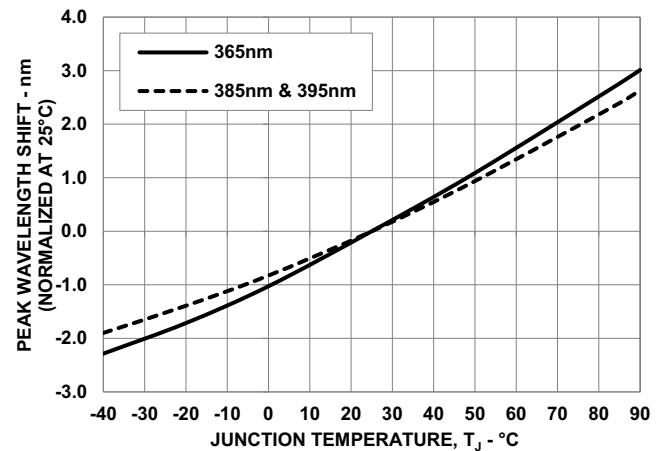


Figure 13: Maximum Forward Current vs. Ambient Temperature – 365 nm

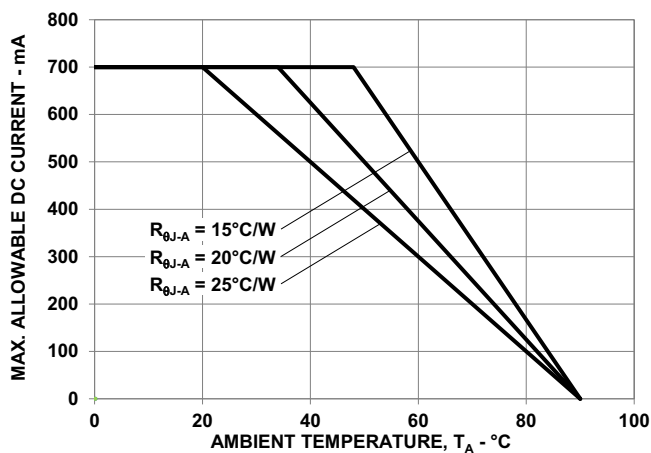


Figure 14: Maximum Forward Current vs. Solder Point Temperature – 365 nm

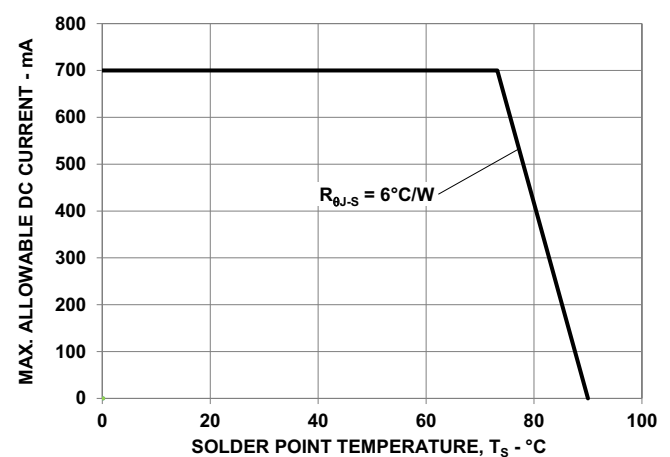


Figure 15: Maximum Forward Current vs. Ambient Temperature – 385 nm and 395 nm

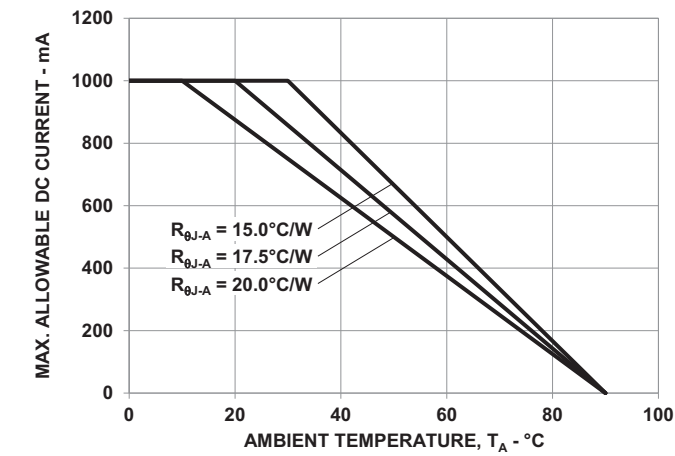


Figure 16: Maximum Forward Current vs. Solder Point Temperature – 385 nm and 395 nm

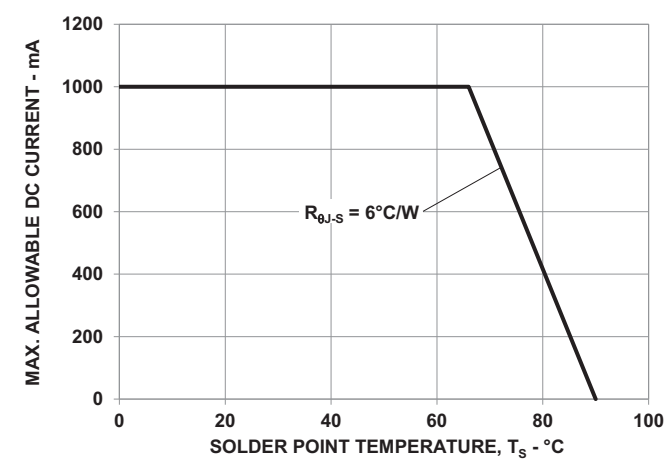
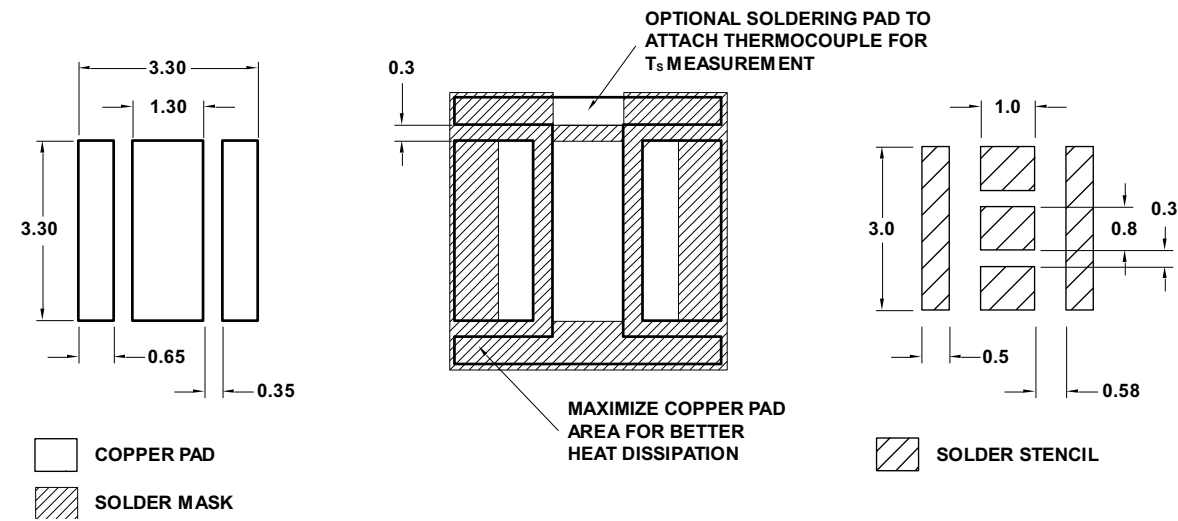
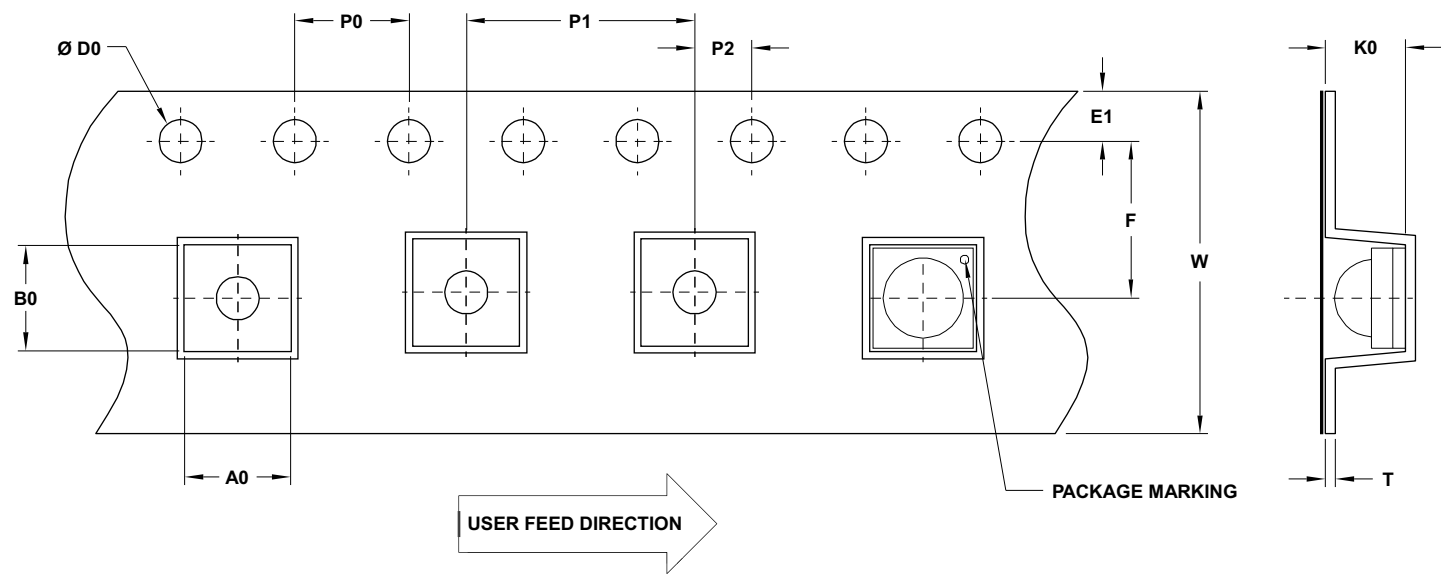


Figure 17: Recommended Soldering Land Pattern



**NOTE:** All dimensions are in millimeters (mm).

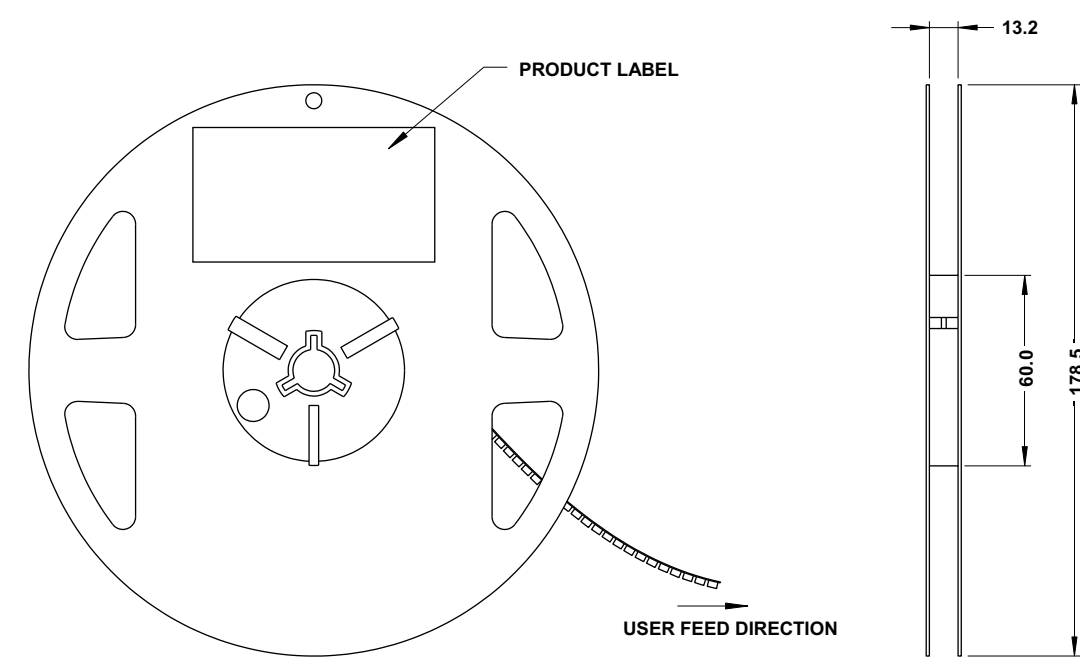
Figure 18: Carrier Tape Dimensions



| F           | P0          | P1          | P2          | D0         | E1          | W            |
|-------------|-------------|-------------|-------------|------------|-------------|--------------|
| 5.50 ± 0.05 | 4.00 ± 0.10 | 8.00 ± 0.10 | 2.00 ± 0.05 | 1.50 + 0.1 | 1.75 ± 0.10 | 12.00 ± 0.20 |
| T           | B0          | A0          | K0          |            |             |              |
| 0.35 ± 0.05 | 3.75 ± 0.10 | 3.75 ± 0.10 | 2.80 ± 0.10 |            |             |              |

**NOTE:** All dimensions are in millimeters (mm).

Figure 19: Reel Dimensions



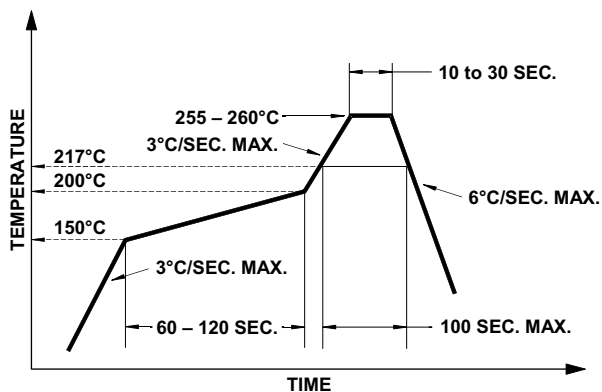
**NOTE:** All dimensions are in millimeters (mm).

## Precautionary Notes

### Soldering

- Do not perform reflow soldering more than twice. Observe necessary precautions of handling moisture-sensitive devices as stated in the following section.
- Do not apply any pressure or force on the LED during reflow and after reflow when the LED is still hot.

Figure 20: Recommended Lead-Free Reflow Soldering Profile



### Handling Precautions

- Do not stack assembled PCBs together. Use an appropriate rack to hold the PCBs.
- For automated pick and place, Broadcom has tested a nozzle size with OD 3.7 mm and ID 3.00 mm to work with this LED. However, due to the possibility of variations in other parameters such as pick and place machine maker/model, and other settings of the machine, verify that the selected nozzle will not cause damage to the LED.

### Handling of Moisture-Sensitive Devices

This product has a Moisture Sensitive Level 1 rating per JEDEC J-STD-020. Refer to Broadcom Application Note AN5305, *Handling of Moisture Sensitive Surface Mount Devices*, for additional details and a review of proper handling procedures.

#### Storage:

Keep unused LEDs in a sealed moisture barrier bag (MBB) with desiccant or in a desiccator at <5% RH as prolonged exposure to ambient temperature might affect the solderability performance.

### Application Precautions

- The drive current of the LED must not exceed the maximum allowable limit across temperature as stated in the data sheet. Constant current driving is recommended to ensure consistent performance.
- The circuit design must cater to the whole range of forward voltage ( $V_F$ ) of the LEDs to ensure the intended drive current can always be achieved.
- The LED exhibits slightly different characteristics at different drive currents, which may result in a larger variation of performance (such as intensity, wavelength, and forward voltage). Set the application current as close as possible to the test current to minimize these variations.
- Do not use the LED in the vicinity of material with sulfur content or in environments of high gaseous sulfur compounds and corrosive elements. Examples of material that might contain sulfur are rubber gaskets, room-temperature vulcanizing (RTV) silicone rubber, rubber gloves, and so on. Prolonged exposure to such environments may affect the optical characteristics and product life.
- Avoid rapid changes in ambient temperatures, especially in high-humidity environments, because they cause condensation on the LED.
- If the LED is intended to be used in a harsh or an outdoor environment, protect the LED against damages caused by rain water, water, dust, oil, corrosive gases, external mechanical stresses, and so on.

## Thermal Management

The optical, electrical, and reliability characteristics of the LED are affected by temperature. Keep the junction temperature ( $T_J$ ) of the LED below the allowable limit at all times.  $T_J$  can be calculated as follows:

$$T_J = T_A + R_{\theta J-A} \times I_F \times V_{Fmax}$$

where:

$T_A$  = Ambient temperature ( $^{\circ}\text{C}$ )

$R_{\theta J-A}$  = Thermal resistance from LED junction to ambient ( $^{\circ}\text{C/W}$ )

$I_F$  = Forward current (A)

$V_{Fmax}$  = Maximum forward voltage (V)

The complication of using this formula lies in  $T_A$  and  $R_{\theta J-A}$ . Actual  $T_A$  is sometimes subjective and hard to determine.  $R_{\theta J-A}$  varies from system to system depending on design and is usually not known.

Another way of calculating  $T_J$  is by using the solder point temperature,  $T_S$ , as follows:

$$T_J = T_S + R_{\theta J-S} \times I_F \times V_{Fmax}$$

where:

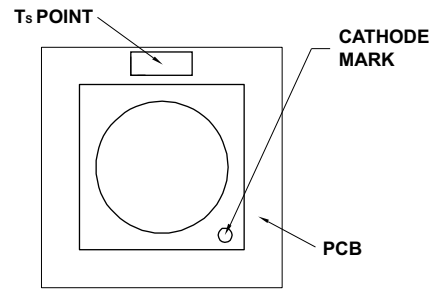
$T_S$  = LED solder point temperature as shown in the following figure ( $^{\circ}\text{C}$ )

$R_{\theta J-S}$  = Thermal resistance from junction to solder point ( $^{\circ}\text{C/W}$ )

$I_F$  = Forward current (A)

$V_{Fmax}$  = Maximum forward voltage (V)

Figure 21: Solder Point Temperature on PCB



$T_S$  can be easily measured by mounting a thermocouple on the soldering joint as shown in preceding figure, while  $R_{\theta J-S}$  is provided in the data sheet. Verify the  $T_S$  of the LED in the final product to ensure that the LEDs are operating within all maximum ratings stated in the data sheet.

## Eye Safety Precautions

These devices are UV LEDs that may pose optical hazards when in operation. **Do not** look directly into an emitting UV LED because it might be harmful to human eyes. For safety precautions, use appropriate shielding or personal protective equipment (for example, glasses, gloves, face shield). Use appropriate warning signs and labels to indicate the presence of potential UV radiation hazard.

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